



100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET **PowerDI**

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C		
100V	16mΩ @ V _{GS} = 10V	44A		
1007	18mΩ @ V _{GS} = 6V	41A		

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R_{DS(ON)}, yet maintain superior switching performance. This device is ideal for use in notebook battery power management and loadswitch.

PowerDI5060-8

Applications

- Motor Control
- DC-DC Converters
- Power Management

Features

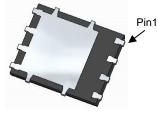
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

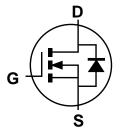
- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.097 grams (Approximate)



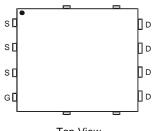




Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH10H015LPS-13	PowerDI5060-8	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



);; = Manufacturer's Marking TH1015LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 16 = 2016) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	100	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Dusin Compant (Nata 5) \ (A0) /	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	7.3 5.8	А
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I _D	44 28	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	120	Α
Maximum Continuous Body Diode Forward Current (Note 5)			I _S	1.5	Α
Avalanche Current (Note 7) L=3mH			I _{AS}	7.5	Α
Avalanche Energy (Note 7) L=3mH			E _{AS}	85	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P _D	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	98	°C/W	
Total Power Dissipation	T _C = +25°C	P_{D}	46	W
Thermal Resistance, Junction to Case	R _{0JC}	2.7	°C/W	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

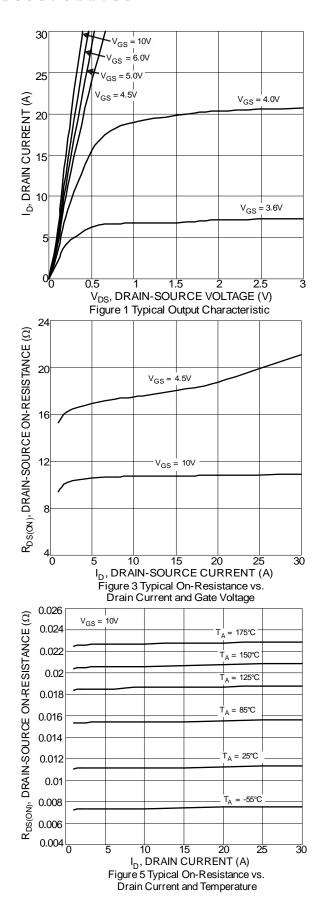
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)						•	
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)						•	
Gate Threshold Voltage	$V_{GS(TH)}$	1.4	2	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		_	11	16		V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	13.5	18	mΩ	$V_{GS} = 6V, I_D = 20A$	
	, ,		18.4	25		$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V_{SD}		0.9	1.3	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 7)			•	•		•	
Input Capacitance	C _{ISS}	_	1,871	_			
Output Capacitance	Coss	_	261	_	pF	$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	C _{RSS}	_	7	_			
Gate Resistance	R _G	_	0.75	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_{G}	_	33.3	_			
Gate-Source Charge	Q _{GS}		6.9	_	$N_{DD} = 50V, I_{D} = 10A,$		
Gate-Drain Charge	Q_{GD}	_	5.1	_		$V_{GS} = 10V$	
Turn-On Delay Time	t _{D(ON)}		6.5	_			
Turn-On Rise Time	t _R	_	7	_		$V_{DD} = 50V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}		19.7	_	ns	$I_D = 10A$, $R_G = 6\Omega$	
Turn-Off Fall Time	t _F		8.1	_			
Reverse Recovery Time	t _{RR}		37.9	_	ns	1 404 41/41 4004/45	
Reverse Recovery Charge	Q _{RR}		51.9	_	nC	I _F = 10A, di/dt = 100A/μs	

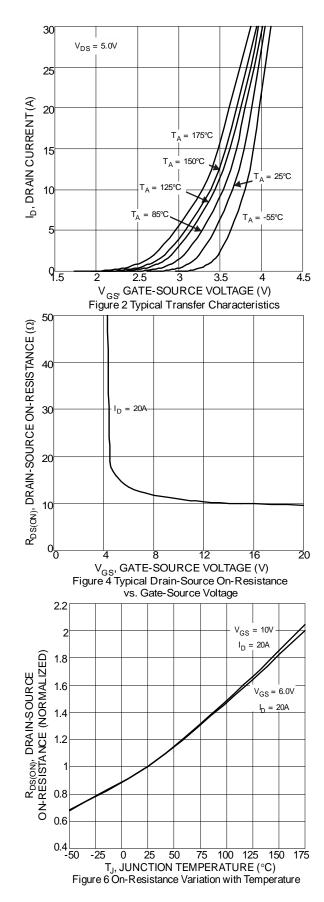
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

DMTH10H015LPS Document number: DS38713 Rev. 2 - 2

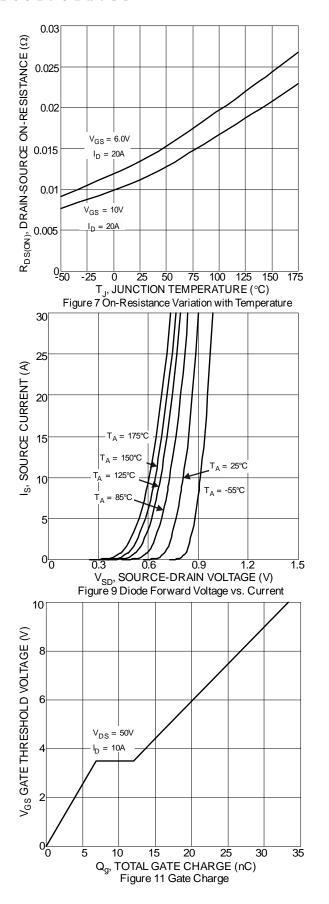
^{6.} Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing.

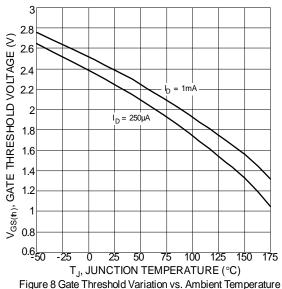


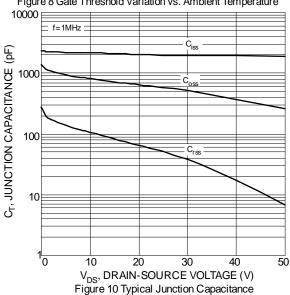


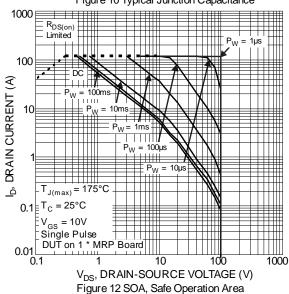




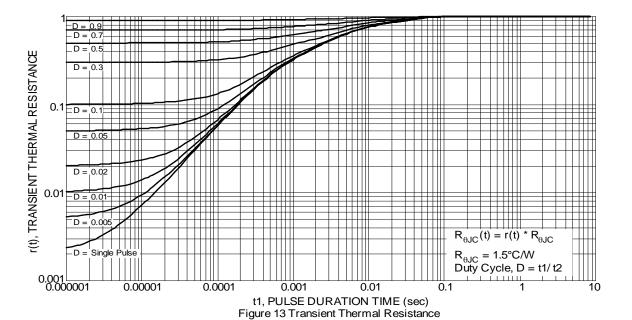










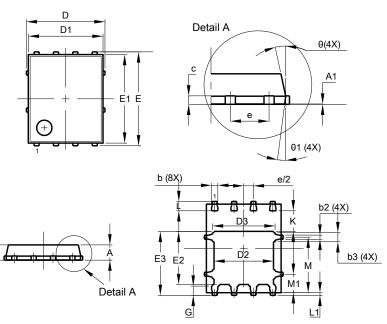




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

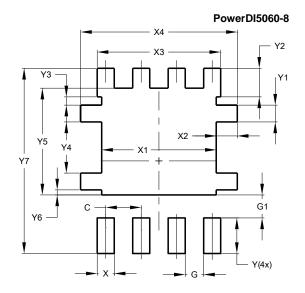
PowerDI5060-8



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PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	•	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90 4.30 4.10				
E	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	_	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)				
С	1.270				
G	0.660				
G1	0.820				
X	0.610				
X1	4.100				
X2	0.755				
Х3	4.420				
X4	5.610				
Y	1.270				
Y1	0.600				
Y2	1.020				
Y3	0.295				
Y4	1.825				
Y5	3.810				
Y6	0.180				
Y7	6.610				



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